

FMV15N60S1

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FUJI POWER MOSFET

Super J-MOS series

N-Channel enhancement mode power MOSFET

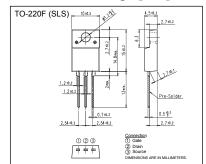
Features

Pb-free lead terminal RoHS compliant

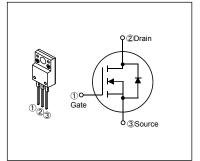
Applications

For switching

Outline Drawings [mm]



Equivalent circuit schematic



■ Absolute Maximum Ratings at T_c=25°C (unless otherwise specified)

Parameter	Symbol	Characteristics	Unit	Remarks	
Dunin Course Voltage	V _{DS}	600	V		
Drain-Source Voltage	V _{DSX}	600	V	V _{GS} =-30V	
	lo	±15	Α	Tc=25°C Note*1	
Continuous Drain Current		±9.5	Α	Tc=100°C Note*1	
Pulsed Drain Current	I _{DP}	±45	Α	Note *1	
Gate-Source Voltage	V _{GS}	±30	V		
Repetitive and Non-Repetitive Maximum Avalanche Current	I _{AR}	3.7	А	Note *2	
Non-Repetitive Maximum Avalanche Energy	Eas	506.5	mJ	Note *3	
Maximum Drain-Source dV/dt	dV _{DS} /dt	50	kV/μs	V _{DS} ≤ 600V	
Peak Diode Recovery dV/dt	dV/dt	15	kV/μs	Note *4	
Peak Diode Recovery -di/dt	-di/dt	100	A/µs	Note *5	
Marrian Dames Dispiration	Б	2.16	10/	T _a =25°C	
Maximum Power Dissipation	P₀	48	W	Tc=25°C	
On another and Standard Temperature and a	Tch	150	°C		
Operating and Storage Temperature range	T _{stg}	-55 to +150	°C		
Isolation Voltage	Viso	2	kVrms	t=60sec, f=60Hz	

Note *1 : Limited by maximum channel temperature.

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Note *2: Tch≤150°C, See Fig.1 and Fig.2

Note *3: Starting Tch=25°C, Ias=2.3A, L=176mH, Vbb=60V, Rc=50Ω, See Fig.1 and Fig.2

Eas limited by maximum channel temperature and avalanche current.

Note *4: Ir≤-lb, -di/dt=100A/μs, Vbs peak≤600V, Tch≤150°C.

Note *5: Ir≤-lb, dV/dt=15kV/μs, Vbs peak≤600V, Tch≤150°C.

■ Electrical Characteristics at T_c=25°C (unless otherwise specified) Static Ratings

Parameter	Symbol	Conditions		min.	typ.	max.	Unit
Drain-Source Breakdown Voltage	BV _{DSS}	I _D =250µA V _{GS} =0V		600	-	-	V
Gate Threshold Voltage	V _{GS(th)}	I _D =250µA V _{DS} =V _{GS}		2.5	3.0	3.5	V
Zero Gate Voltage Drain Current	Ioss	V _{DS} =600V V _{GS} =0V	T _{ch} =25°C	-	-	25	μА
		V _{DS} =480V V _{GS} =0V	T _{ch} =125°C	-	-	250	
Gate-Source Leakage Current	Igss	V _{GS} = ± 30V V _{DS} =0V		-	10	100	nA
Drain-Source On-State Resistance	R _{DS(on)}	I _D =7.5A V _{GS} =10V		-	0.195	0.23	Ω
Gate resistance	R _G	f=1MHz, open drain		-	3.4	-	Ω

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• Dynamic Ratings

Parameter	Symbol	Conditions	min.	typ.	max.	Unit
Forward Transconductance	gfs	I _D =7.5A V _{DS} =25V	7.3	14.7	-	S
Input Capacitance	Ciss	V _{DS} =400V	-	1050	-	
Output Capacitance	Coss	V _{GS} =0V	-	34	-	
Reverse Transfer Capacitance	Crss	f=250kHz	-	3.2	-	
Effective output capacitance, energy related (Note *6)	C _{o(er)}	V _{GS} =0V V _{DS} =0480V	-	77	-	pF
Effective output capacitance, time related (Note *7)	C _{o(tr)}	V _{cs} =0V V _{cs} =0480V ID=constant	-	256	-	
Turn-On Time	t _{d(on)}		-	32	-	
Turn-On Time	t _r	V_{DD} =400V, V_{GS} =10V I_{D} =7.5A, R_{G} =24 Ω	-	13.5	-	ns
Turn-Off Time	t _{d(off)}	See Fig.3 and Fig.4	-	124	-	
Turn-On Time	t _f		-	17.5	-	
Total Gate Charge	Q _G	V _{DD} =480V, I _D =15A V _{SS} =10V See Fig.5	-	43	-	
Gate-Source Charge	Q _{GS}		-	11.5	-	nC
Gate-Drain Charge	Q _{GD}		-	13.5	-	IIC
Drain-Source crossover Charge	Qsw		-	7	-	

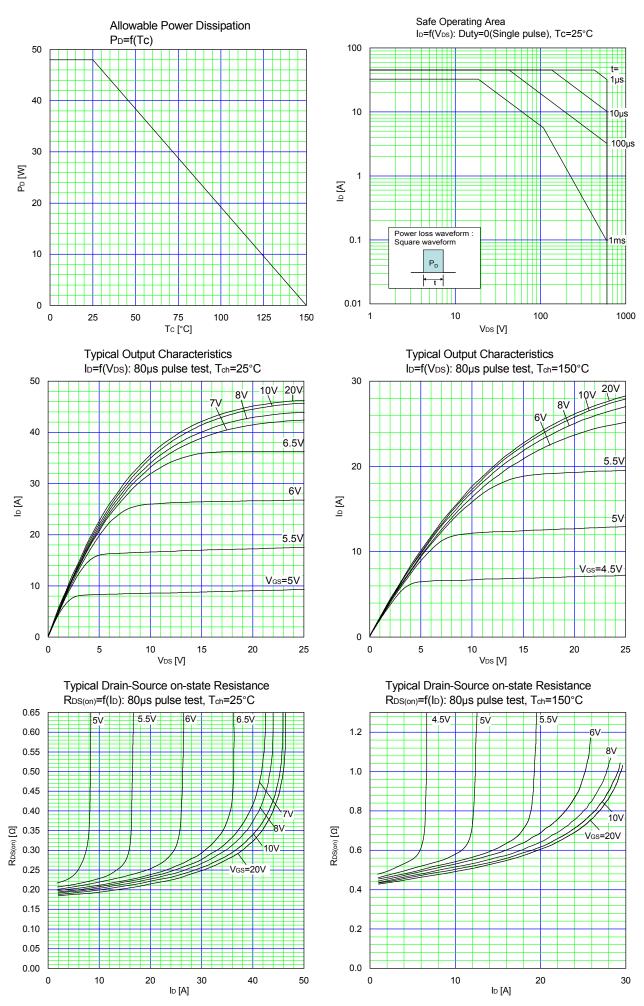
Note *6 : $C_{\text{o(er)}}$ is a fixed capacitance that gives the same stored energy as C_{oss} while V_{DS} is rising from 0 to 80% BVoss. Note *7 : $C_{\text{o(er)}}$ is a fixed capacitance that gives the same charging times as C_{oss} while V_{DS} is rising from 0 to 80% BVoss.

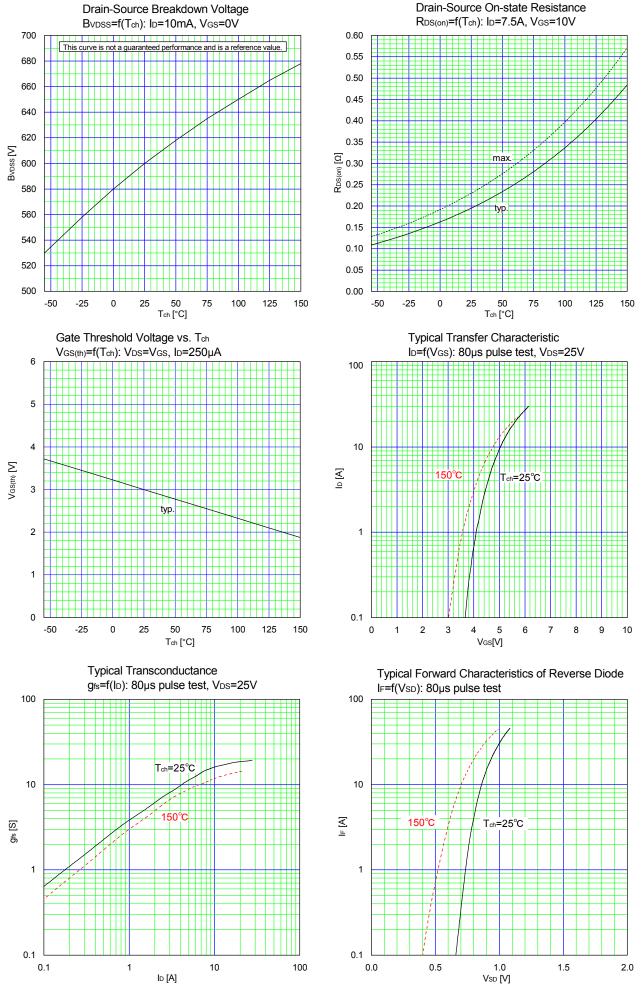
• Reverse Diode

Parameter	Symbol	Conditions	min.	typ.	max.	Unit
Avalanche Capability	lav	L=42.2mH, T _{ch} =25°C See Fig.1 and Fig.2	3.7	-	-	А
Diode Forward On-Voltage	V _{SD}	I _F =15A, V _{GS} =0V T _{ch} =25°C	-	0.9	1.35	V
Reverse Recovery Time	trr	I _F =15A, V _{DD} =400V -di/dt=100A/µs T _{ch} =25°C See Fig.6 and Fig.7		345	-	ns
Reverse Recovery Charge	Qrr		-	5	-	μC
Peak Reverse Recovery Current	Irp		-	29	-	А

■ Thermal Resistance

Parameter	Symbol	min.	typ.	max.	Unit
Channel to Case	R _{th(ch-c)}	-	-	2.6	°C/W
Channel to Ambient	R _{th(ch-a)}	-	-	58	°C/W





400

300

200

100

=3.7A

25

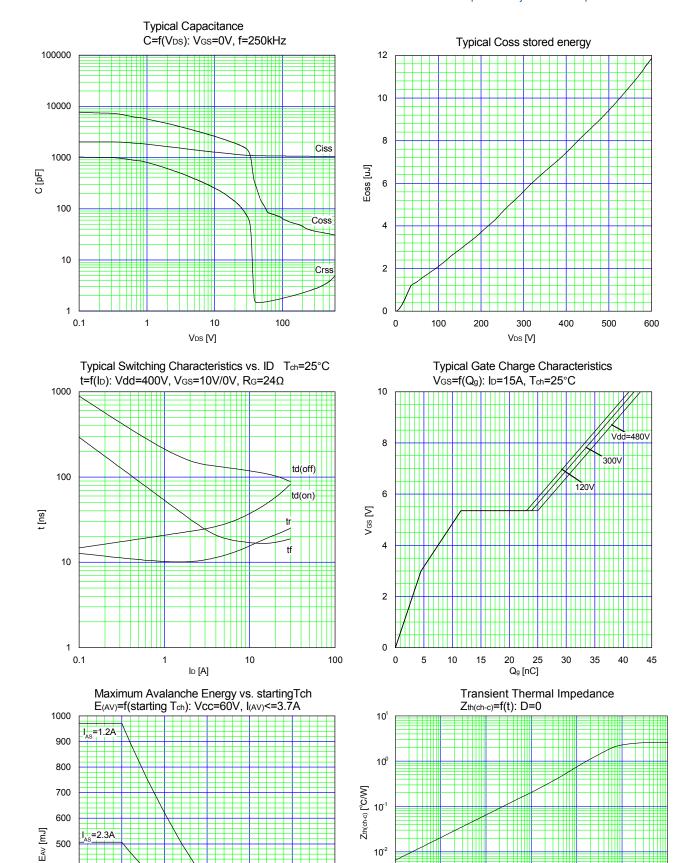
50

75

starting Tch [°C]

100

125



150

10⁻³

 10^{-6}

10⁻⁵

10⁻⁴

10⁻³

t [sec]

10⁻²

10⁻¹

10°

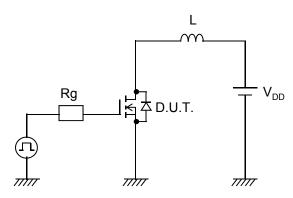


Fig.1 Avalanche Test circuit

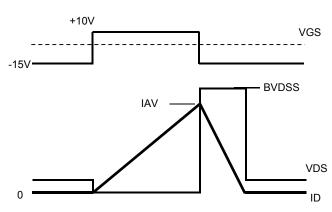


Fig.2 Operating waveforms of Avalanche Test

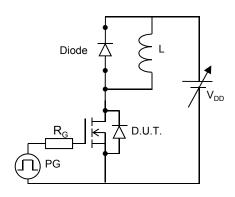


Fig.3 Switching Test circuit

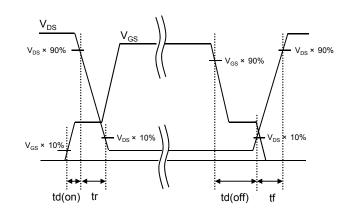


Fig.4 Operating waveform of Switching Test

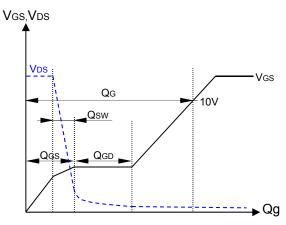


Fig.5 Operating waveform of Gate charge Test

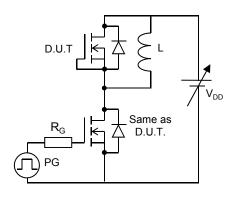


Fig.6 Reverse recovery Test circuit

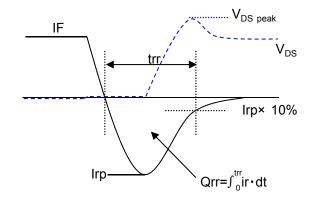
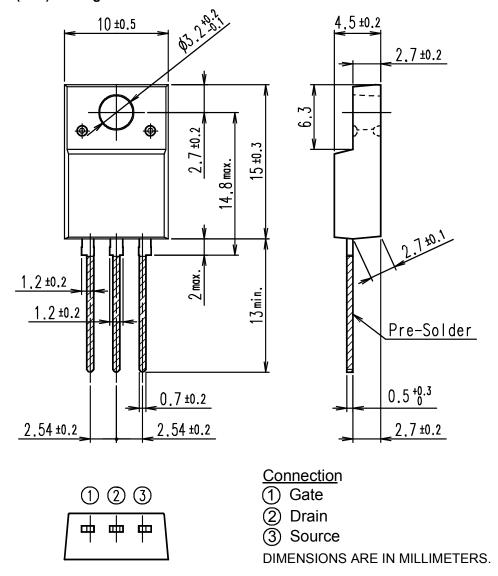
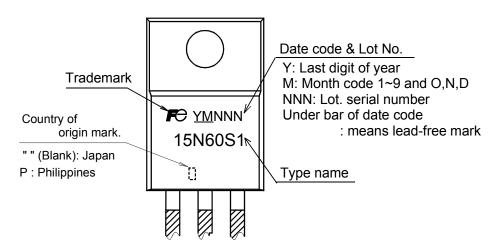


Fig.7 Operating waveform of Reverse recovery Test

Outview: TO-220F (SLS) Package



Marking



* The font (font type,size) and the trademark-size might be actually different.

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- Personal equipment Industrial robots etc.
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